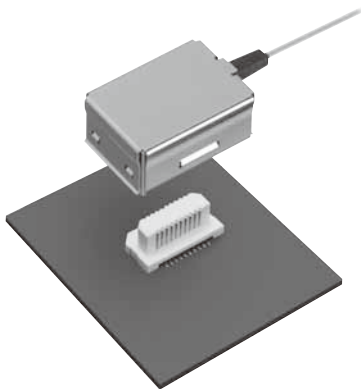


1 channel-Bi-direction/2 channel-Uni-direction

### Active Optical Connector

## V Series

### Easy high speed optical transfer inside devices



### FEATURES

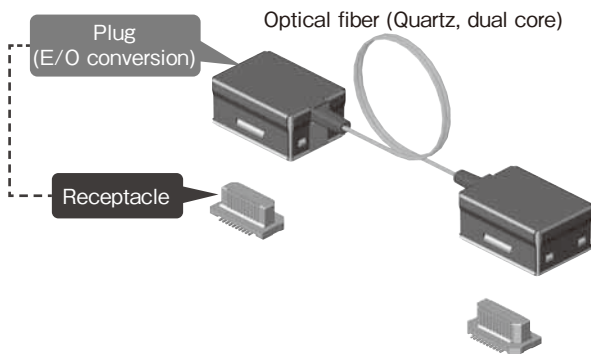
1. Plug is equipped with electrical/ optical conversion function.
  2. Noise reduction of high speed signal and electrical isolation easily achieved.
  3. High speed and wide data rate transmission possible
  4. Lineup includes 1 channel-Bi- direction and 2 channel-Uni-direction
- 1 channel-Bi-direction: 20 Mbps to Max. 6 Gbps  
 2 channel-Uni-direction: 20 Mbps to Max. 16 Gbps (20 Mbps to 8 Gbps/ch)

### APPLICATIONS

Measuring equipment, Image processing instrument, Industrial robots, Printer, Medical equipment, etc. and other high speed transmission, noise reduction and electrical isolation applications

### DETAILED FEATURES

Plug is equipped with electrical/optical conversion function.

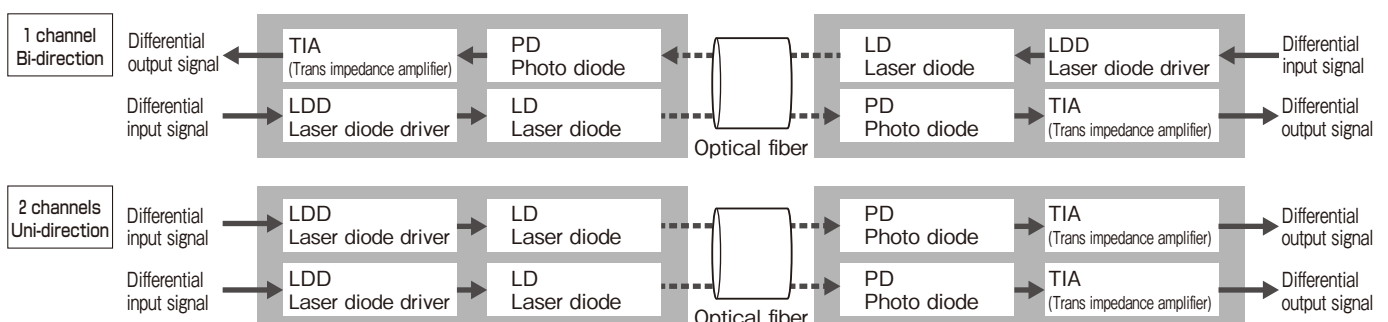


1 channel-Bi-direction: Max. 6 Gbps transmission  
 Being able to reverse the dual core optical fiber transfer direction makes it ideal for such applications as mutual high speed transfer between connected PC boards.

2 channel-Uni-direction: Max. 16 Gbps transmission (8 Gbps/ch)  
 Being able to use the dual core optical fiber unidirectionally makes it ideal for high capacity (max. 16 Gbps) transfer applications.

The differential input signal is converted to an optical signal by the Laser Diode Driver (LDD) and Laser Diode (LD) in the plug.

The optical signal is transmitted through the optical fiber and reproduced as differential output signal by the Photo Diode (PD) and Trans Impedance Amplifier (TIA).



**PRODUCT TYPES (1 channel-Bi-direction)****1. Integrated cable and plug**

Transmission rate	Transmission specifications	Cable length	Part No.	Packing quantity
20 Mbps to 6 Gbps/ch	1 channel-Bi-direction	50 mm	AYG4V10565M1	10 pieces
		500 mm	AYG4V15065M1	
		1000 mm	AYG4V1A065M1	
		50 mm	AYG4V10565M3	100 pieces
		500 mm	AYG4V15065M3	
		1000 mm	AYG4V1A065M3	

**2. Receptacle (both 1 channel-Bi-direction and 2 channel-Uni-direction)**

Product type	Part No.	Packing quantity
Receptacle	AXK6S20447M1	20 pieces
	AXK6S20447M3	200 pieces (reel)

**SPECIFICATIONS (1 channel-Bi-direction)****1. Rated specifications (per channel)**

Item	Min.	Typical	Max.	Unit	Condition
Supply voltage	3.2	3.3	3.4	V	—
Power consumption	—	—	230	mW	Bi-direction 1channel
Transmission rate (per channel)	0.02	—	6	Gbps	8b/10b coding
Input/output characteristic impedance	80	100	125	$\Omega$	—
Differential input voltage	400	—	1600	mVpp	peak-to-peak
Input common mode voltage	150	—	340	mV	*1
Input total jitter	—	—	0.24	UI	*2
Input rise-time	—	—	0.30	UI	20 to 80%*2, *3
Input fall-time	—	—	0.30	UI	20 to 80%*2, *3
Differential output voltage	300	440	550	mVpp	peak-to-peak*2
Output common mode voltage	150	250	275	mV	*2
Output rise-time	—	—	0.50	UI	20 to 80%*2
Output fall-time	—	—	0.50	UI	20 to 80%*2
Output total jitter	—	—	0.60	UI	Dj + Rjpp*2

\*1: When performing AC coupling, the input common mode voltage is 0 to 1.8 V.

\*2: Input data pattern is PRBS 2<sup>7</sup>-1. Rjpp is equivalent to BER 10<sup>-12</sup>.

\*3: When the transmission rate is under 1.5 Gbps, the time is up to 200 ps.

**2. Use conditions**

Item	Performance	Remarks
Operating ambient temperature	0 to +70°C	No icing at low temperatures. No condensation.
Storage temperature	-20 to +50°C (packaged form) -20 to +85°C (product only)	No icing at low temperatures. No condensation.
Relative humidity	20 to 80%RH	No condensation.
Electrical static discharge	2kV	Applied 3 times on the external shell C = 100pF, R = 1.5k $\Omega$ C = 150pF, R = 330 $\Omega$
Immunity	Conformed to IEC61000-6-2 standard	—
Electromagnetic interference	Conformed to VCCI class B standard	—
Composite insertion force	Max. 15.7N (initial)	—
Composite removal force	Min. 1.17N	—
Insertion and removal life	50 times	Repeated insertion and removal cycles of Max. 200 times/hour

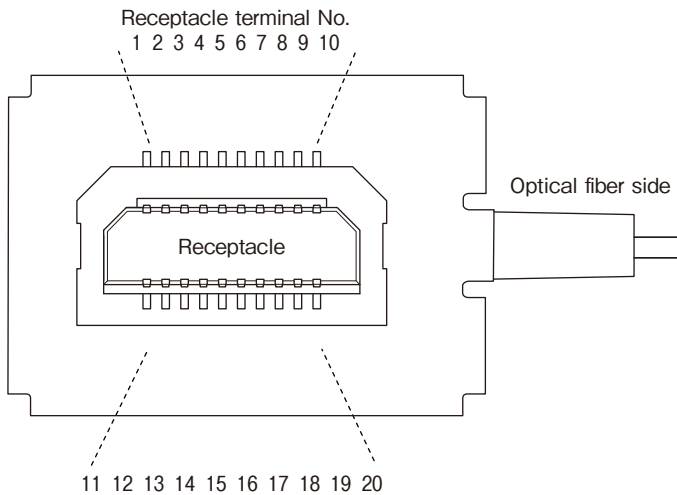
# Active Optical Connector V Series (1 channel-Bi-direction/2 channel-Uni-direction)

## 3. Materials specifications

Component name	Materials	Specifications and Remarks
Shell	Copper alloy	Nickel plating
Bushing	Elastomer	Black
Optical fiber	Silica, UV-cured resin	Cross section: 0.4 × 0.6 mm, 2 cores
Connector	LCP resin, copper alloy	Terminal (Au-plating on Ni-base)
Photoelectric conversion PC board	Glass-fibered epoxy, epoxy resin, etc.	—
IC	CMOS	—
Laser Diode	GaAs	—
Photo diode	GaAs	—

## TERMINAL LAYOUT 1 channel-Bi-direction

Terminal layout diagram (Viewed from the top, receptacle as transparent)



No.	Name
1	Monitor
2	GND
3	Differential output -
4	Differential output +
5	GND
6	Open
7	Open
8	Power Supply
9	Power Supply
10	GND
11	Open
12	GND
13	Differential input -
14	Differential input +
15	GND
16	GND
17	Power Supply
18	Power Supply
19	Power Supply
20	GND

**PRODUCT TYPES (2 channel-Uni-direction)****1. Integrated cable and plug**

Transmission rate	Transmission specifications	Cable length	Part No.	Packing quantity
20 Mbps to 8 Gbps/ch	2 channel-Uni-direction	50 mm	AYG5V10585M1	10 pieces
		500 mm	AYG5V15085M1	
		1000 mm	AYG5V1A085M1	
		50 mm	AYG5V10585M3	100 pieces
		500 mm	AYG5V15085M3	
		1000 mm	AYG5V1A085M3	

**2. Receptacle (both 1 channel-Bi-direction and 2 channel-Uni-direction)**

Product type	Part No.	Packing quantity
Receptacle	AXK6S20447M1	20 pieces
	AXK6S20447M3	200 pieces (reel)

**SPECIFICATIONS (2 channel-Uni-direction)****1. Rated specifications (per channel)**

Item	Min.	Typical	Max.	Unit	Condition
Supply voltage	3.2	3.3	3.4	V	—
Power consumption	—	—	230	mW	Uni-direction, 2 channels
Transmission rate (per channel)	0.02	—	8	Gbps	8b/10b coding
Input/output characteristic impedance	80	100	125	$\Omega$	—
Differential input voltage	400	—	1600	mVpp	peak-to-peak
Input common mode voltage	150	—	340	mV	*1
Input total jitter	—	—	0.24	UI	*2
Input rise-time	—	—	0.30	UI	20 to 80%*2, *3
Input fall-time	—	—	0.30	UI	20 to 80%*2, *3
Differential output voltage	300	440	550	mVpp	peak-to-peak*2
Output common mode voltage	150	250	275	mV	*2
Output rise-time	—	—	0.50	UI	20 to 80%*2
Output fall-time	—	—	0.50	UI	20 to 80%*2
Output total jitter	—	—	0.60	UI	Dj + Rjpp*2

\*1: When performing AC coupling, the input common mode voltage is 0 to 1.8 V.

\*2: Input data pattern is PRBS 2<sup>7</sup>-1. Rjpp is equivalent to BER 10<sup>-12</sup>.

\*3: When the transmission rate is under 1.5 Gbps, the time is up to 200 ps.

**2. Use conditions**

Item	Performance	Remarks
Operating ambient temperature	0 to +70°C	No icing at low temperatures. No condensation.
Storage temperature	-20 to +50°C (packaged form) -20 to +85°C (product only)	No icing at low temperatures. No condensation.
Relative humidity	20 to 80%RH	No condensation.
Electrical static discharge	2kV	Applied 3 times on the external shell C = 100pF, R = 1.5k $\Omega$ C = 150pF, R = 330 $\Omega$
Immunity	Conformed to IEC61000-6-2 standard	—
Electromagnetic interference	Conformed to VCCI class B standard	—
Composite insertion force	Max. 15.7N (initial)	—
Composite removal force	Min. 1.17N	—
Insertion and removal life	50 times	Repeated insertion and removal cycles of Max. 200 times/hour

# Active Optical Connector V Series (1 channel-Bi-direction/2 channel-Uni-direction)

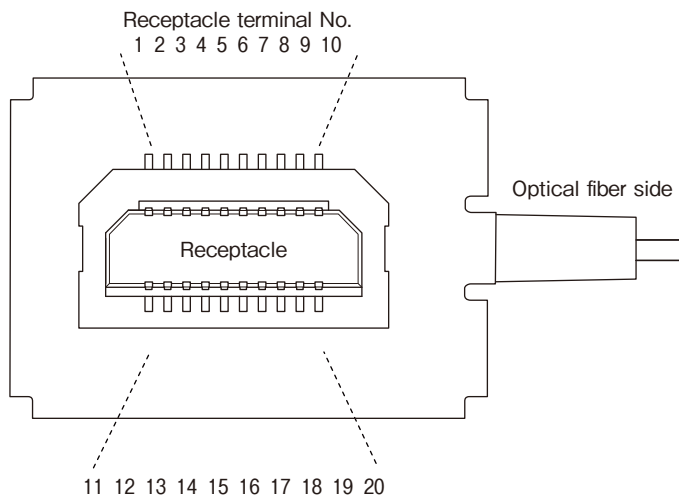
## 3. Materials specifications

Component name	Materials	Specifications and Remarks
Shell	Copper alloy	Nickel plating
Bushing	Elastomer	Black
Optical fiber	Silica, UV-cured resin	Cross section: 0.4 × 0.6 mm, 2 cores
Connector	LCP resin, copper alloy	Terminal (Au-plating on Ni-base)
Photoelectric conversion PC board	Glass-fibered epoxy, epoxy resin, etc.	—
IC	CMOS	—
Laser Diode	GaAs	—
Photo diode	GaAs	—

## TERMINAL LAYOUT 2 channel-Uni-direction

### Transmitter side

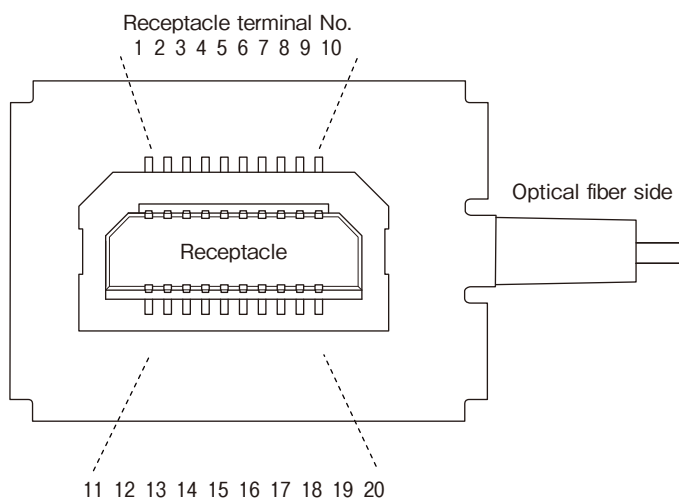
Terminal layout diagram (Viewed from the top, receptacle as transparent)



No.	Name
1	Open
2	GND
3	ch1 Differential input +
4	ch1 Differential input -
5	GND
6	Open
7	Power Supply
8	Power Supply
9	Open
10	GND
11	Open
12	GND
13	ch2 Differential input -
14	ch2 Differential input +
15	GND
16	Open
17	Power Supply
18	Power Supply
19	Open
20	GND

### Receiver side

Terminal layout diagram (Viewed from the top, receptacle as transparent)

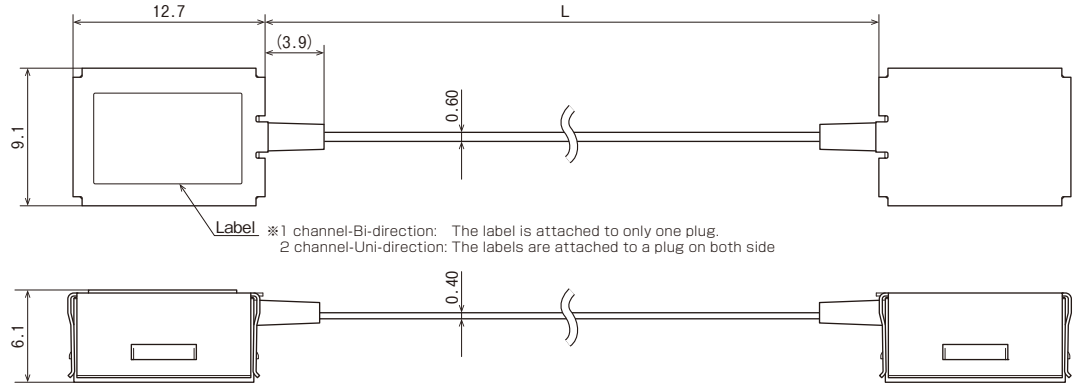


No.	Name
1	Open
2	GND
3	ch2 Differential output -
4	ch2 Differential output +
5	GND
6	Monitor (ch2)
7	Open
8	Open
9	Power Supply
10	GND
11	Open
12	GND
13	ch1 Differential output +
14	ch1 Differential output -
15	GND
16	Monitor (ch1)
17	Open
18	Open
19	Power Supply
20	GND

# Active Optical Connector V Series (1 channel-Bi-direction/2 channel-Uni-direction)

## DIMENSIONS (both 1 channel-Bi-direction and 2 channel-Uni-direction) (Unit: mm)

### Integrated cable and plug



Label ※ 1 channel-Bi-direction: The label is attached to only one plug.  
2 channel-Uni-direction: The labels are attached to a plug on both side

General tolerance:  $\pm 0.3$

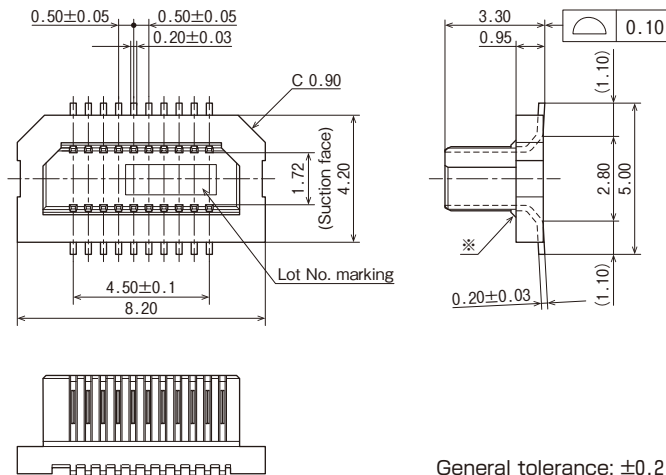
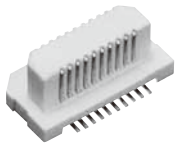
### 1 channel-Bi-direction

L: Cable length (mm)	Tolerance (mm)
50	+10 -0
500	+50 -0
1000	+100 -0

### 2 channel-Uni-direction

L: Cable length (mm)	Tolerance (mm)
50	+10 -0
500	+50 -0
1000	+100 -0

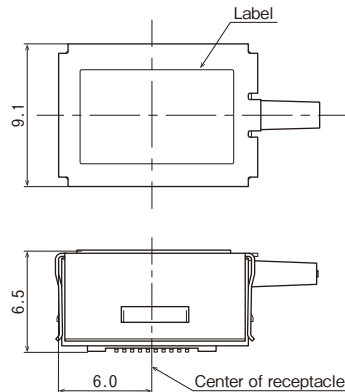
### Receptacle



General tolerance:  $\pm 0.2$

※The terminal close to the portion to be soldered have nickel barriers (except nickel portions).

### Plug and receptacle are mated

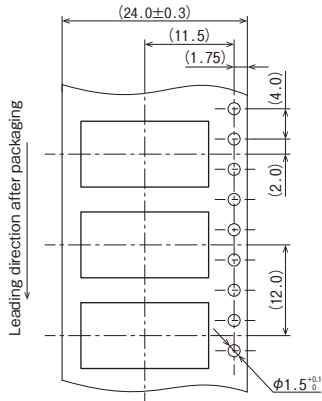


## EMBOSSED TAPE DIMENSIONS (Unit: mm)

### Receptacle: Embossed tape packaging

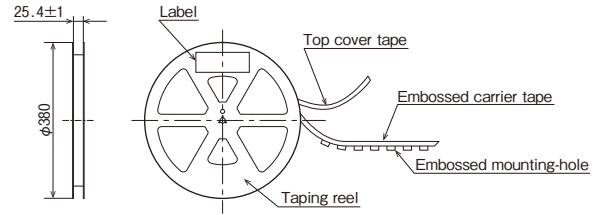
Specifications for taping

In accordance with JIS C 0806:1990. However, not applied to the mounting-hole pitch of some connectors.



Specifications for the plastic ree

In accordance with EIAJ ET-7200B.



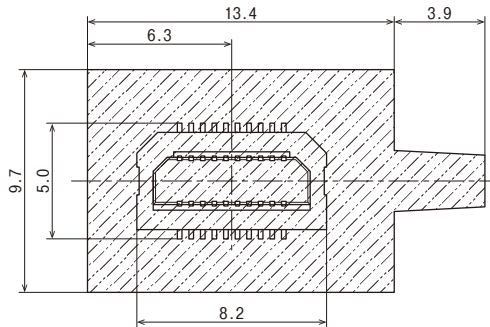
### Receptacle orientation with respect to embossed tape feeding direction

Direction of tape progress	Type	Receptacle

## NOTES (Unit: mm)

### Mounting layout (Component prohibited area)

The shaded area cannot be used for the placement of other components since it is used by the active optical connector. The PC board in the shaded area should be covered with solder resist except for the receptacle's mounting pad.



# Active Optical Connector V Series (1 channel-Bi-direction/2 channel-Uni-direction)

## Design of PC board patterns

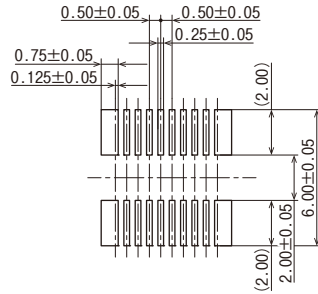
Conduct the recommended foot pattern design, in order to preserve the mechanical strength of terminal solder areas.

### Recommended PC board and metal mask patterns

Connectors are mounted with high pitch density, intervals of 0.35 mm, 0.4 mm or 0.5 mm. In order to reduce solder and flux rise, solder bridges and other issues make sure the proper levels of solder is used.

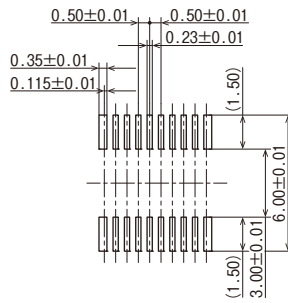
The figures are recommended patterns. Please use them as a reference.

#### Recommended PC board pattern (TOP VIEW)



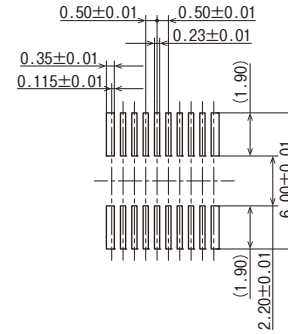
#### Recommended metal mask pattern

Metal mask thickness: When 150 $\mu$ m  
(Opening area ratio: 69%)



#### Recommended metal mask pattern

Metal mask thickness: When 120 $\mu$ m  
(Opening area ratio: 87%)



Please refer to the latest product specifications when designing your product.



# Notes on Using Active Optical Connector V Series

## About safety remarks

Observe the following safety remarks to prevent accidents and injuries.

- 1) Do not use these connectors beyond the specification sheets. The usage outside of specified rated current, dielectric strength, and environmental conditions and so on may cause circuitry damage via abnormal heating, smoke, and fire.
- 2) In order to avoid accidents, your thorough specification review is appreciated. Please contact our sales office if your usage is out of the specifications. Otherwise, Panasonic Corporation cannot guarantee the quality and reliability.
- 3) Panasonic Corporation is consistently striving to improve quality and reliability. However, the fact remains that electrical components and devices generally cause failures at a given statistical probability. Furthermore, their durability varies with use environments or use conditions. In this respect, please check for actual electrical components and devices under actual conditions before use. Continued usage in a state of degraded

condition may cause the deteriorated insulation, thus result in abnormal heat, smoke or firing. Please carry out safety design and periodic maintenance including redundancy design, design for fire spread prevention, and design for malfunction prevention so that no accidents resulting in injury or death, fire accidents, or social damage will be caused as a result of failure of the products or ending life of the products.

- 4) Caution at the time of a breakage of optical fiber  
When the optical fiber breaks, immediately shut off the power. This product uses a laser diode (class 1) of non-visible light with oscillation wavelength 850 nm. The laser beam does not irradiate outside in normal operation, but a breakage of the optical fiber may cause irradiation outside. When the optical fiber breaks, be very careful not to injury at the fiber tip.

## Cautions when using the product

### 1. Cautions about the operating and storage environments

Please use the product in accordance with the conditions described in these specifications.

The product quality cannot be warranted if the product fails because it is used outside the conditions in these specifications.

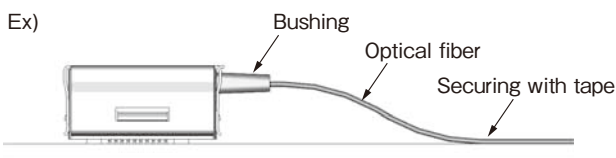
- 1) Product failure due to condensation cannot be warranted.
- 2) Use caution for avoiding dust.

4) This product has a structure requiring an insertion force for mating, but the mating may come off when an external force is applied to the plug, impact is applied by dropping, or vibration is applied in equipment. Sufficient caution should be used with the equipment to avoid such incidents.

5) The product cannot be used in a movable parts while the optical fiber is bent. Such use may cause deformation of the receptacle or breakage of the optical fiber.

6) In order to avoid a load on the plug and receptacle applied by the tensile force of the optical fiber, a redundant design is required with respect to the optical fiber length.

7) Use caution for wiring the optical fiber to avoid getting entangled or twisting. Also, use adhesive tape for securing the optical fiber for preventing excessive stress caused by vibration and impact.



3) The following environment may deteriorate the product's appearance and affect the product characteristics, and should thus be avoided.

- An environment in which the possible adherence of chemicals such as acid and alkali exists.
- In a gaseous atmosphere of salt, sulfide, etc.

8) Insertion and removal operations must be performed while the power is off.

Insertion or removal operations in a live condition (with current and voltage) may lead to a breakage.

9) Use caution with regard to the generation and handling of static electricity in the operating environment to protect the plug.

10) Secure sufficient insulation distance between the external metal enclosure of the plug and the peripheral components. The plug enclosure, which is connected to the ground, may give rise to danger from a short-circuit.

When the product is used in a different environment and in accordance with a method other than described in this document, please contact our sales office.

11) Do not disassemble this product. Doing so will cause malfunction. Also, do not remove the label. The product control number is there.

## Plug

### 1. Direction of mating and insertion

1 channel-Bi-direction

Mating of the plug and receptacle requires orientation. Align the receptacle shape in the direction of the optical fiber of plug.

2-channel-Uni-direction

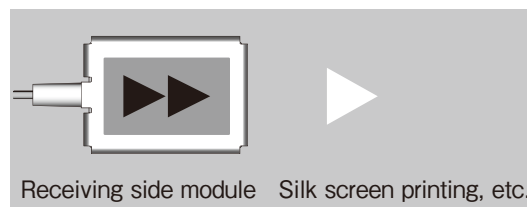
The plugs on each end of the optical fiber cable are different (transmission side and receiving side).

The cable will not work if inserted incorrectly; therefore, please verify the ends prior to installation.

The receiving end plug has an arrow printed on it for the purpose of verification.

Please implement a measure to avoid incorrect insertion such as by printing a similar mark on the PC board.

Example of avoid incorrect insertion

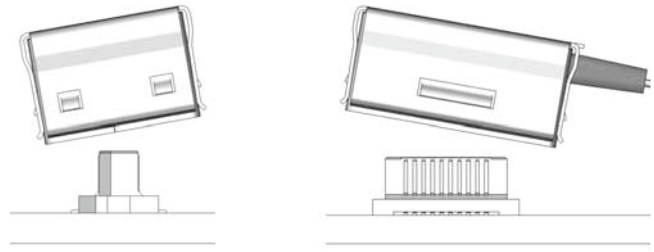


# Notes on Using Active Optical Connector V Series

## 2. Insertion

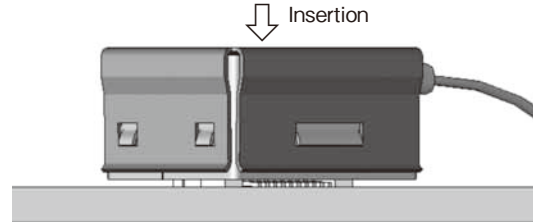
Because this product has been designed with a thin mating structure between the plug and receptacle for compact-sizing purposes, excessive tilting during insertion or removal leads to product fracture and separation of the solder section of terminals.

For avoiding breakage of the mating parts, confirm the alignment before mating.



## 3. Mating of plug

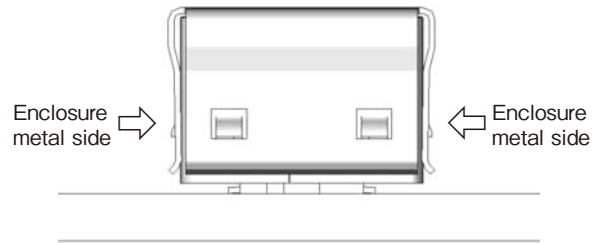
Make sure the plug is securely inserted into the receptacle. After mating, a gap remains between the PC board and plug. Avoid applying excessive pressure.



## 4. Plug removal

For the removal operation, hold both sides of the metal enclosure and lift the plug upward.

Do not pull the optical fiber and bushing.

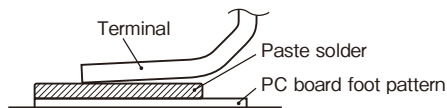


## Receptacle

### 1. Regarding soldering

Reflow soldering

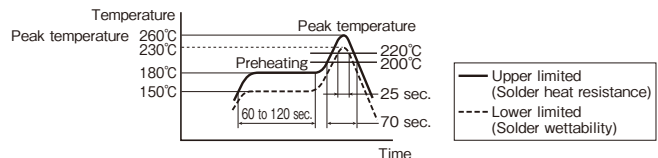
- 1) Measure the recommended profile temperature for reflow soldering by placing a sensor on the PC board near the connector surface or terminals. (Please refer to the specification for detail because the temperature setting differs by products.)
- 2) As for cream solder printing, screen printing is recommended.
- 3) When setting the screen opening area and PC board foot pattern area, refer the recommended PC board pattern and window size of metal mask on the specification sheet, and make sure that the size of board pattern and metal mask at the base of the terminals are not increased.
- 4) Please pay attentions not to provide too much solder. It makes miss mating because of interference at soldering portion when mating.



- 5) When mounting on both sides of the PC board and the connector is mounting on the underside, use adhesives or other means to ensure the connector is properly fixed to the PC board. (Double reflow soldering on the same side is possible.)
- 6) The condition of solder or flux rise and wettability varies depending on the type of solder and flux. Solder and flux characteristics should be taken into consideration and also set the reflow temperature and oxygen level.
- 7) Do not use resin-containing solder. Otherwise, the contacts might be firmly fixed.

### 8) Soldering conditions

Please use the reflow temperature profile conditions recommended below for reflow soldering. Please contact our sales office before using a temperature profile other than that described below (e.g. lead-free solder)



9) The temperature profiles given in this catalog are values measured when using the connector on a resin-based PC board. When performed reflow soldering on a metal board (iron, aluminum, etc.) or a metal table to mount on a FPC, make sure there is no deformation or discoloration of the connector before mounting.

10) Please contact our sales office when using a screen-printing thickness other than that recommended.

## Manual soldering

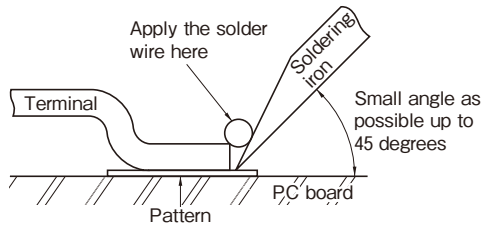
1) Set the soldering iron so that the tip temperature is less than that given in the table below.

Table A

Product name	Soldering iron temperature
SMD type connectors all products	300°C within 5 sec. 350°C within 3 sec.

2) Do not allow flux to spread onto the connector leads or PC board. This may lead to flux rising up to the connector inside.

3) Touch the soldering iron to the foot pattern. After the foot pattern and connector terminal are heated, apply the solder wire so it melts at the end of the connector terminals.



4) Be aware that soldering while applying a load on the connector terminals may cause improper operation of the connector.

5) Thoroughly clean the soldering iron.

6) Flux from the solder wire may get on the contact surfaces during soldering operations. After soldering, carefully check the contact surfaces and clean off any solder before use.

7) These connector is low profile type. If too much solder is supplied for hand soldering, It makes miss mating because of interference at soldering portion. Please pay attentions.

## Solder reworking

1) Finish reworking in one operation.

2) In case of soldering rework of bridges. Do not use supplementary solder flux. Doing so may cause contact problems by flux.

3) Keep the soldering iron tip temperature below the temperature given in Table A.

## 2. Handling single components

1) Make sure not to drop or allow parts to fall from work bench.  
2) Excessive force applied to the terminals could cause warping, come out, or weaken the adhesive strength of the solder. Handle with care.

3) Do not insert or remove the connector when it is not soldered. Forcibly applied external pressure on the terminals can weaken the adherence of the terminals to the molded part or cause the terminals to lose their evenness.

## 3. Cleaning flux from PC board

There is no need to clean this product.

If cleaning it, pay attention to the following points to prevent the negative effect to the product.

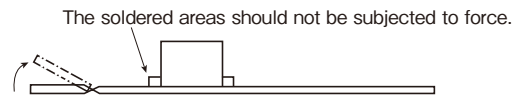
1) Keep the cleaning solvent clean and prevent the connector contacts from contamination.

2) Some cleaning solvents are strong and they may dissolve the molded part and characters, so pure water passed liquid solvent is recommended.

## 4. Handling the PC board

Handling the PC board after mounting the connector

When cutting or bending the PC board after mounting the connector, be careful that the soldered sections are subjected to excessive force.



## 5. Storage of connectors

1) To prevent problems from voids or air pockets due to heat of reflow soldering, avoid storing the connectors in areas of high humidity.

2) Depending on the connector type, the color of the connector may vary from connector to connector depending on when it is produced. Some connectors may change color slightly if subjected to ultraviolet rays during storage. This is normal and will not affect the operation of the connector.

3) When storing the connectors with the PC boards assembled and components already set, be careful not to stack them up so the connectors are subjected to excessive forces.

4) Avoid storing the connectors in locations with excessive dust. The dust may accumulate and cause improper connections at the contact surfaces.

## 6. Other Notes

1) Do not remove or insert the electrified connector (in the state of carrying current or applying voltage).

2) Dropping of the products or rough mishandling may bend or damage the terminals and possibly hinder proper reflow soldering.

3) Before soldering, try not to insert or remove the connector more than absolutely necessary.

4) When coating the PC board after soldering the connector to prevent the deterioration of insulation, perform the coating in such a way so that the coating does not get on the connector.

5) There may be variations in the colors of products from different production lots. This is normal.

6) The connectors are not meant to be used for switching.

7) Product failures due to condensation are not covered by warranty.

Please refer to the latest product specifications when designing your product.

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Please contact .....

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